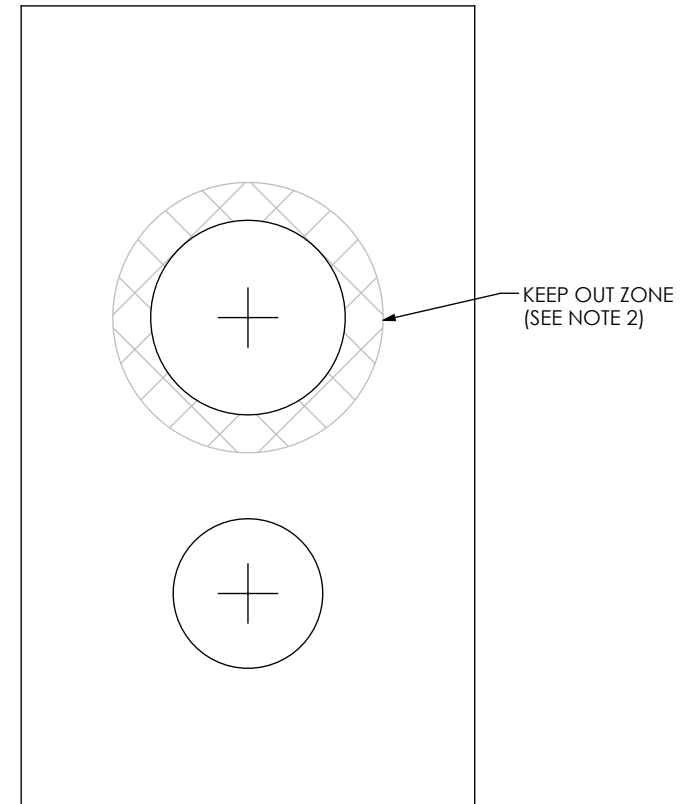


ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.

FIG 1 (FRONT VIEW)



BACK VIEW

NOTES:

1. SEE APPLICATION SPECIFICATION AND EBTX FOOTPRINT DRAWINGS FOR INFORMATION REGARDING PCB LAYOUT OF GUIDE MODULES RELATIVE TO SIGNAL MODULES.
2. DO NOT PUT TOP LEVEL TRACES OR VIAS IN THESE KEEP OUT ZONES. USE APPROPRIATE CLEARANCE ON THE BOTTOM OF THE PCB DEPENDING ON HARDWARE USED.
3. 1.60 [.063] MIN BOARD THICKNESS.

F

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